

SAEINDIA to Host APAC 23 in New Delhi, Bringing AsiaPacific's Mobility Engineering Community Together

23rd Edition of Asia Pacific Automotive Engineering Conference 2026 to convene 1,000+ delegates, 500+ mobility experts and industry leaders from across the region from 13-14 November 2026 at Yashobhoomi, New Delhi

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SAEINDIA is set to host APAC 23 – 23rd Asia Pacific Automotive Engineering Conference 2026, one of the region's prominent forums for automotive and mobility engineering, from 13-14 November 2026 at Yashobhoomi Convention Centre, New Delhi.



Organised under the theme “Xcellerating towards Safe, Secure, Sustainable & Intelligent Mobility,” APAC 23 will bring together mobility leaders, engineers, technologists, researchers, policymakers, academia, start-ups and solution providers from India and across the Asia-Pacific region to exchange ideas, showcase emerging technologies and explore the future of mobility.

The conference assumes special significance for India as SAEINDIA hosts APAC for the second time after a gap of 15 years, placing the country at the centre of an influential regional dialogue on the technologies and engineering solutions shaping the next generation of transportation.

A Legacy of Collaboration Across Asia-Pacific

Originating in 1981 as the International Pacific Conference, APAC has evolved into a collaborative automotive engineering forum representing 11 countries across the Asia-Pacific region. Over the decades, it has created a platform for engineering communities to exchange knowledge, strengthen international collaboration and address emerging challenges across the automotive and mobility ecosystem.



As the global mobility sector undergoes rapid transformation driven by electrification, software, artificial intelligence, connectivity, automation, sustainability and evolving safety requirements, APAC 23 will provide a timely platform to examine how engineering innovation can translate these developments into safe, secure and sustainable mobility solutions.

Bringing the Mobility Ecosystem Under One Roof

APAC 23 is expected to welcome 1,000+ delegates and 500+ mobility experts, with participation from leading automotive OEMs, component manufacturers, technology companies, engineering service providers, research organisations, academic institutions, start-ups and government and regulatory stakeholders.



The two-day conference is expected to feature 150+ technical presentations and 80+ exhibitors, creating an extensive platform for knowledge exchange, technology demonstration, business networking and cross-border collaboration.

Technical discussions at APAC 23 will span some of the most important areas influencing the future of mobility, including:

Future Powertrains

Automated, Connected,

Safe & Smart Mobility

Cybersecurity & Artificial Intelligence

Software-Defined Vehicles and Vehicle as a Digital Platform

Digital Transformation & Digital Twins

Vehicle Dynamics Human Factors

Advanced Materials & Lightweighting

Energy, Emissions & Life Cycle Assessment Standards & Regulations

Beyond a Conference: An Integrated Mobility Platform

APAC 23 has been designed as more than a conventional technical conference. Alongside plenary and technical sessions, the event will feature an Exposition, TechHive, Technology Theatre and dedicated networking and business engagement opportunities, enabling participants to experience mobility innovation from multiple perspectives.



The APAC 23 Exposition will provide organisations with a platform to demonstrate technologies, products, engineering capabilities and next-generation mobility solutions to a highly relevant audience of industry professionals and decision-makers.

The Technology Theatre, located within the exposition area, will offer an interactive platform for organisations to present new technologies, solutions, product innovations and engineering developments directly to conference participants.

TechHive: Giving Mobility Start-ups a Global Stage

A major highlight of APAC 23 will be TechHive, a dedicated platform created to connect mobility start-ups with the wider automotive ecosystem.

TechHive will provide emerging companies with opportunities to showcase innovations, interact with industry leaders, technology experts, investors, potential customers and collaborators, and build visibility within the Asia-Pacific mobility community.

Through TechHive, APAC 23 aims to strengthen the connection between emerging innovation and established industry, encouraging collaborations capable of accelerating new mobility technologies from concept to real-world application.



India at the Centre of the Mobility Transformation India is rapidly emerging as one of the world's most significant mobility markets and engineering hubs. The convergence of a large automotive manufacturing ecosystem, strong engineering talent, an expanding start-up landscape and increasing investments in electric, connected, software-defined and sustainable mobility presents a unique opportunity for the country. By bringing APAC back to India after 15 years, SAEINDIA aims to facilitate deeper engagement between India and the wider Asia-Pacific automotive engineering community and create new opportunities for technology exchange, research collaboration, partnerships and business development.

Opportunities for Industry Participation

With the conference approaching, SAEINDIA is inviting organisations and professionals across the mobility ecosystem to participate in APAC 23 through delegate registrations, sponsorship, exposition and TechHive.

The conference offers organisations an opportunity to position their technologies and capabilities before a focused audience, engage with mobility decision-makers and engineering professionals, develop new partnerships and contribute to conversations defining the future direction of mobility in the Asia-Pacific region.

APAC 23 – Asia Pacific Automotive Engineering Conference 2026

Dates: 13–14 November 2026 Venue: Yashobhoomi Convention Centre, New Delhi, India

Theme: “Xellerating towards Safe, Secure, Sustainable & Intelligent Mobility”

About SAEINDIA

SAEINDIA is a leading professional engineering society dedicated to advancing mobility knowledge and solutions in India. It brings together engineers, industry professionals, researchers, academicians and students across the mobility ecosystem and facilitates technical knowledge sharing, professional development, industry-academia collaboration and engineering innovation.

Through conferences, technical programmes, professional development initiatives, student competitions and industry engagement platforms, SAEINDIA contributes to developing engineering capabilities and advancing mobility technologies in India.

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